



WWW.100Y.COM.TW

### N-Channel 30 V (D-S) MOSFET

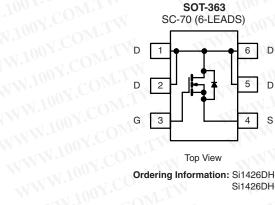
PRODUCT	SUMMARY	CON
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A
20	0.075 at V <sub>GS</sub> = 10 V	3.6
30	0.115 at V <sub>GS</sub> = 4.5 V	2.9

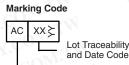
- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- Thermally Enhanced SC-70 Package
- **PWM Optimized**
- Compliant to RoHS Directive 2002/95/EC



#### **APPLICATIONS**

- Boost Converter in Portable Devices - Low Gate Charge (3 nC)
- Low Current Synchronous Rectifier





Part # Code

Ordering Inform	nation: Si1426DH-T1-E3 Si1426DH-T1-GE	(Lead (Pb)-free) 3 (Lead (Pb)-free a	nd Halogen-free)			
ABSOLUTE MAXIMUM RATINGS	T <sub>A</sub> = 25 °C, unles	s otherwise n	oted	WWW.1	WY.CO	
Parameter	7	Symbol	5 s	Steady State	Unit	
Drain-Source Voltage	$V_{DS}$	OMITW	30			
Gate-Source Voltage		$V_{GS}$	± 20		100Y.	
Continuous Drain Current (T <sub>J</sub> = 150 °C) <sup>a</sup>	T <sub>A</sub> = 25 °C	MMila	3.6	2.8	N. P.	
	T <sub>A</sub> = 85 °C	ID 00	<sup>1</sup> D 2.6	2.1	M.100	
Pulsed Drain Current		I <sub>DM</sub>	MI	10	A00	
Continuous Diode Current (Diode Conduction) <sup>a</sup>	W	I <sub>S</sub>	1.3	0.8		
CC CC	T <sub>A</sub> = 25 °C	1111 W.10	1.6	1.0	111111111111111111111111111111111111111	
Maximum Power Dissipation <sup>a</sup>	T <sub>A</sub> = 85 °C	$P_{D}$	0.8	0.5	W	
Operating Junction and Storage Temperature Ran	nge	T <sub>J</sub> , T <sub>stg</sub>	- 58	5 to 150	°C	

operating denotion and delarge remperature riange		· J· · sig	00 to 100		
THERMAL RESISTANCE RATII	NGS	V	W.1007.	M.TW	WW
Parameter	MY.CO	Symbol	Typical	Maximum	Unit
Manipular Landing to Applicate	t ≤ 5 s	<b>B</b>	60	80	
Maximum Junction-to-Ambient <sup>a</sup>	Steady State	R <sub>thJA</sub>	100	125	°C/W
Maximum Junction-to-Foot (Drain)	Steady State	R <sub>thJF</sub>	34	45	]

#### Note:

a. Surface mounted on 1" x 1" FR4 board.

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

Http://www. 100y. com. tw

Document Number: 71805 S10-0935-Rev. B, 19-Apr-10

#### Vishay Siliconix



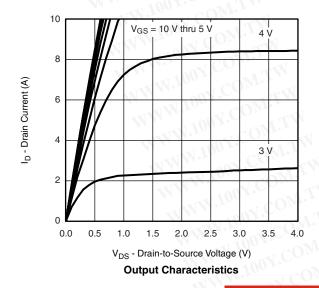
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	1007.	WY 10	01.0	WIN			
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	0.80	W	2.5	V	
Gate-Body Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	- <1 C	Mr.	± 100	nA	
Zero Gate Voltage Drain Current I <sub>DSS</sub>		$V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 24 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 85 \text{ °C}$		$OM_{-1}$	1		
				1007.0		μΑ	
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} = 5 \text{ V}, V_{GS} = 10 \text{ V}$	10	COR		Α	
Dia Colon Bain a DAN		$V_{GS} = 10 \text{ V}, I_D = 3.6 \text{ A}$	1.700	0.061	0.075	0	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	$V_{GS} = 4.5 \text{ V}, I_D = 2.0 \text{ A}$	0.092	0.092	0.115	Ω	
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	$V_{DS} = 10 \text{ V}, I_D = 3.6 \text{ A}$	100	5	I.I.M	S	
Diode Forward Voltage <sup>a</sup>	$V_{SD}$	$I_S = 1.3 \text{ A}, V_{GS} = 0 \text{ V}$	MA.	0.78	1.2	٧	
Dynamic <sup>b</sup>	TW.	M. LO. COM.	MW.	any.Cl	)IA.		
Total Gate Charge	Qg	M.Ing. COM.	WW.	1.9	3	<b>M</b>	
Gate-Source Charge	Q <sub>gs</sub>	$V_{DS} = 15 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 3.6 \text{ A}$	W TAN	0.75	T.Mor	nC	
Gate-Drain Charge	Q <sub>gd</sub>		MAN	0.75			
Turn-On Delay Time	t <sub>d(on)</sub>	M. For CONT.	WW	10	15	TW	
Rise Time	t <sub>r</sub>	$V_{DD}$ = 15 V, $R_L$ = 15 $\Omega$		12	18		
Turn-Off Delay Time	t <sub>d(off)</sub>	$I_D\cong$ 1 A, $V_{GEN}$ = 10 V, $R_g$ = 6 $\Omega$		15	22	ns	
Fall Time	t <sub>f</sub>		W	9	15		
Source-Drain Reverse Recovery	t <sub>rr</sub>	I <sub>F</sub> = 1.4 A, dI/dt = 100 A/μs	41	40	70		

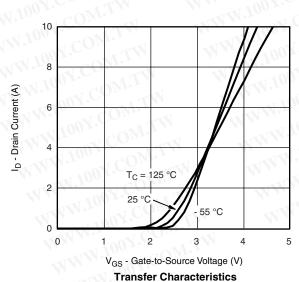
#### Notes

- a. Pulse test; pulse width  $\leq$  300  $\mu$ s, duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

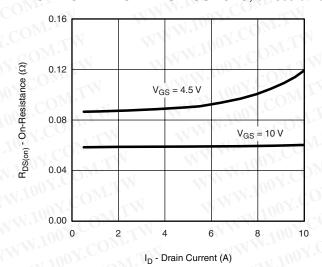


勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

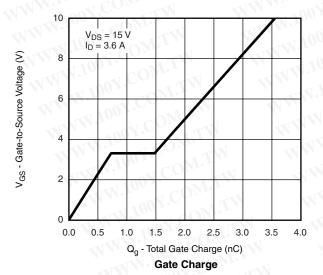
**Si1426DH** 

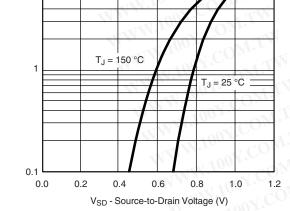
Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

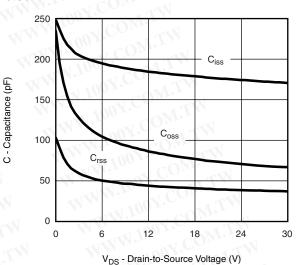


#### On-Resistance vs. Drain Current

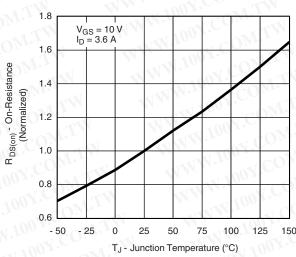




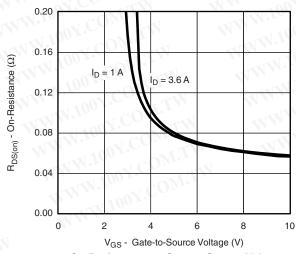
Source-Drain Diode Forward Voltage



Capacitance



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

10

I<sub>S</sub> - Source Current (A)

#### Si1426DH

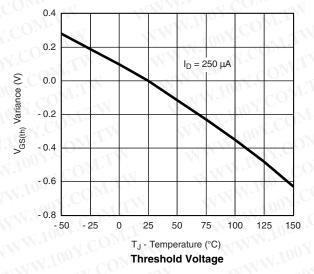
勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

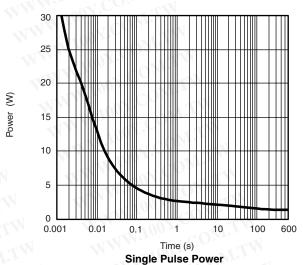
Http://www.100y.com.tw

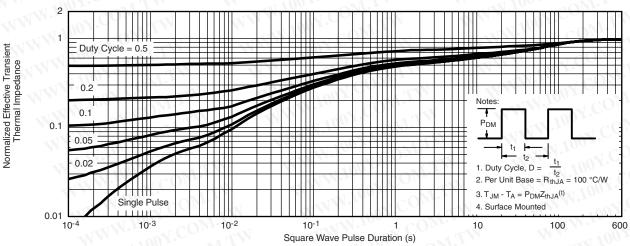
# VISHAY

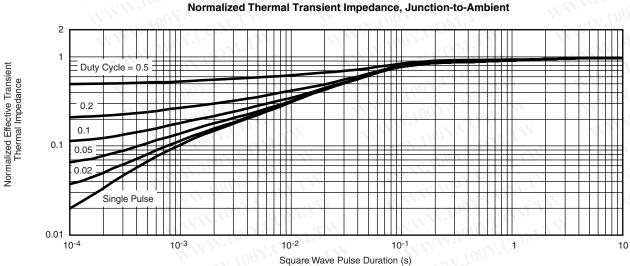
#### Vishay Siliconix

#### TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



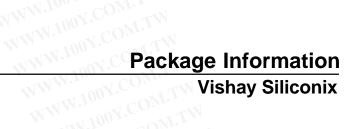






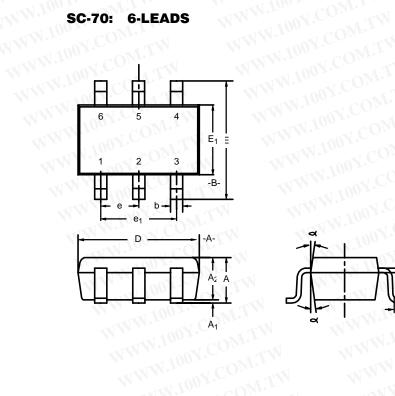
Normalized Thermal Transient Impedance, Junction-to-Foot

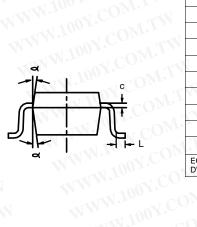
Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see <a href="https://www.vishay.com/ppg271805">www.vishay.com/ppg271805</a>.





## WW.100Y.COM.TW 6-LEADS





WW.100Y.COM.TW

WWW.100Y.COM

WWW.100Y.COM.TW

WWW.100Y.COM.

	MILLIMETERS			INCHES			
Dim	Min	Nom	Max	Min	Nom	Max	
Α	0.90	-01	1.10	0.035	-	0.043	
A <sub>1</sub>		1700.	0.10	V7.7	_	0.004	
A <sub>2</sub>	0.80	700	1.00	0.031	N _	0.039	
b	0.15	14.5	0.30	0.006	-W-	0.012	
С	0.10	W-10	0.25	0.004	- <u>-</u>	0.010	
D	1.80	2.00	2.20	0.071	0.079	0.087	
Ε	1.80	2.10	2.40	0.071	0.083	0.094	
E <sub>1</sub>	1.15	1.25	1.35	0.045	0.049	0.053	
е		0.65BSC			0.026BSC		
e <sub>1</sub>	1.20	1.30	1.40	0.047	0.051	0.055	
L	0.10	0.20	0.30	0.004	0.008	0.012	
d		7°Nom	- XX 10	0 .	7°Nom	F.A.	
ECN: S-C DWG: 55		v. B, 09-Jul-0	01	001.	aoM	TW	

WWW.100Y.COM.TW WWW.100Y.COM.TW 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw WWW.100Y.COM.TW

WWW.100Y.COM.TW

W.100Y.COM.TW

WW.100Y.COM.TW





# Single-Channel LITTLE FOOT® SC-70 6-Pin MOSFET Copper Leadframe Version Recommended Pad Pattern and Thermal Performance

#### INTRODUCTION

The new single 6-pin SC-70 package with a copper leadframe enables improved on-resistance values and enhanced thermal performance as compared to the existing 3-pin and 6-pin packages with Alloy 42 leadframes. These devices are intended for small to medium load applications where a miniaturized package is required. Devices in this package come in a range of on-resistance values, in n-channel and p-channel versions. This technical note discusses pin-outs, package outlines, pad patterns, evaluation board layout, and thermal performance for the single-channel version.

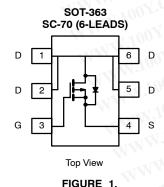
#### **BASIC PAD PATTERNS**

See Application Note 826, Recommended Minimum Pad Patterns With Outline Drawing Access for Vishay Siliconix MOSFETs, (http://www.vishay.com/doc?72286) for the basic pad layout and dimensions. These pad patterns are sufficient for the low to medium power applications for which this package is intended. Increasing the drain pad pattern yields a reduction in thermal resistance and is a preferred footprint. The availability of four drain leads rather than the traditional single drain lead allows a better thermal path from the package to the PCB and external environment.

#### **PIN-OUT**

12-Dec-03

Figure 1 shows the pin-out description and Pin 1 identification. The pin-out of this device allows the use of four pins as drain leads, which helps to reduce on-resistance and junction-to-ambient thermal resistance.



For package dimensions see outline drawing SC-70 (6-Leads) (http://www.vishay.com/doc?71154)

#### **EVALUATION BOARDS — SINGLE SC70-6**

The evaluation board (EVB) measures 0.6 inches by 0.5 inches. The copper pad traces are the same as in Figure 2. The board allows examination from the outer pins to 6-pin DIP connections, permitting test sockets to be used in evaluation testing. See Figure 3.

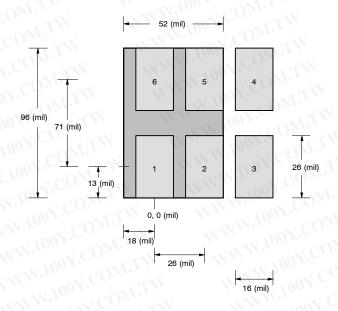


FIGURE 2. SC-70 (6 leads) Single

The thermal performance of the single 6-pin SC-70 has been measured on the EVB, comparing both the copper and Alloy 42 leadframes. This test was first conducted on the traditional Alloy 42 leadframe and was then repeated using the 1-inch<sup>2</sup> PCB with dual-side copper coating.

勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www.100y.com.tw

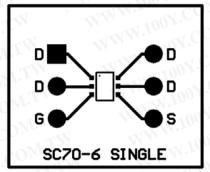
#### Vishay Siliconix

特力材料886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787

Http://www. 100y. com. tw







Back of Board SC70-6

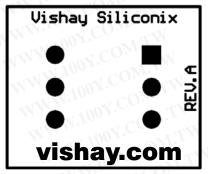


FIGURE 3

#### THERMAL PERFORMANCE

#### Junction-to-Foot Thermal Resistance (Package Performance)

The junction to foot thermal resistance is a useful method of comparing different packages thermal performance.

A helpful way of presenting the thermal performance of the 6-Pin SC-70 copper leadframe device is to compare it to the traditional Alloy 42 version.

Thermal performance for the 6-pin SC-70 measured as junction-to-foot thermal resistance, where the "foot" is the drain lead of the device at the bottom where it meets the PCB. The junction-to-foot thermal resistance is typically 40°C/W in the copper leadframe and 163°C/W in the Alloy 42 leadframe - a four-fold improvement. This improved performance is obtained by the enhanced thermal conductivity of copper over Alloy 42.

#### **Power Dissipation**

The typical  $R\theta_{JA}$  for the single 6-pin SC-70 with copper leadframe is 103°C/W steady-state, compared with 212°C/W for the Alloy 42 version. The figures are based on the 1-inch<sup>2</sup> FR4 test board. The following example shows how the thermal resistance impacts power dissipation for the two different leadframes at varying ambient temperatures.

ALLOY 42 LEADFRAME					
Room Ambient 25 °C	Elevated Ambient 60 °C				
$P_{D} = \frac{T_{J(max)} - T_{A}}{R\theta_{JA}}$	$P_{D} = \frac{T_{J(max)} - T_{A}}{R\theta_{JA}}$				
$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{212^{\circ}C/W}$	$P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{212^{\circ}C/W}$				
$P_D = 590 \text{ mW}$	$P_D = 425 \text{ mW}$				

COOPER LEADFRAME					
Room Ambient 25 °C	Elevated Ambient 60 °C				
$P_{D} = \frac{T_{J(max)} - T_{A}}{R\theta_{JA}}$ $P_{D} = \frac{150^{\circ}C - 25^{\circ}C}{124^{\circ}C/W}$	$P_{D} = \frac{T_{J(max)} - T_{A}}{R\theta_{JA}}$ $P_{D} = \frac{150^{\circ}C - 60^{\circ}C}{124^{\circ}C/W}$				
$P_{D} = 1.01 \text{ W}$	$P_D = 726 \text{ mW}$				

As can be seen from the calculations above, the compact 6-pin SC-70 copper leadframe LITTLE FOOT power MOSFET can handle up to 1 W under the stated conditions.

#### **Testing**

To further aid comparison of copper and Alloy 42 leadframes, Figure 5 illustrates single-channel 6-pin SC-70 thermal performance on two different board sizes and two different pad patterns. The measured steady-state values of  $R\theta_{JA}$  for the two leadframes are as follows:

LITTLE FOOT 6-PIN SC-70					
MAMAGAICO	Alloy 42	Copper			
1) Minimum recommended pad pattern on the EVB board V (see Figure 3.	329.7°C/W	208.5°C/W			
Industry standard 1-inch <sup>2</sup> PCB with maximum copper both sides.	211.8°C/W	103.5°C/W			

The results indicate that designers can reduce thermal resistance ( $R\theta_{1A}$ ) by 36% simply by using the copper leadframe device rather than the Alloy 42 version. In this example, a 121°C/W reduction was achieved without an increase in board area. If increasing in board size is feasible, a further 105°C/W reduction could be obtained by utilizing a 1-inch<sup>2</sup> square PCB area.

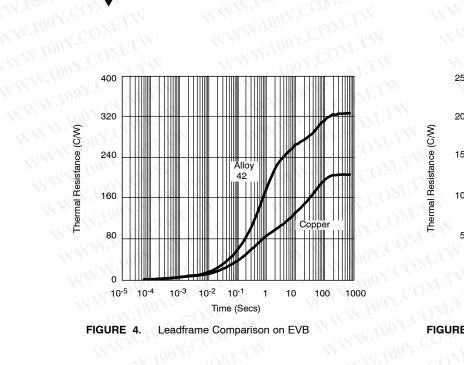
The copper leadframe versions have the following suffix:

Single: Si14xxEDH Dual: Si19xxEDH Complementary: Si15xxEDH

Document Number: 71334 www.vishay.com



# AN815 Vishay Siliconix

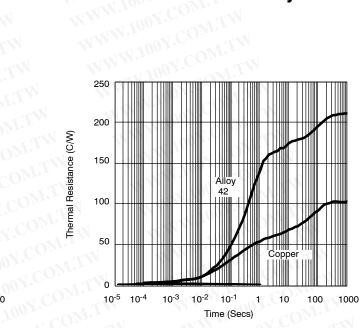


WW.100Y.COM.TW

WWW.100Y.CO

FIGURE 4. Leadframe Comparison on EVB WWW.100Y.CC

WWW.100Y.COM



WWW.100Y.COM.TW

WWW.100Y.C

Leadframe Comparison on Alloy 42 1-inch<sup>2</sup> PCB FIGURE 5. WWW.100Y.C

WWW.100Y.COM.T

WWW.100Y.COM.TW WWW.100Y.COM.TW 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 WWW.100Y.COM.TW Http://www.100y.com.tw

WWW.100Y.COM.TW

N 100Y.COM.TW

WWW.100Y.COM.TW

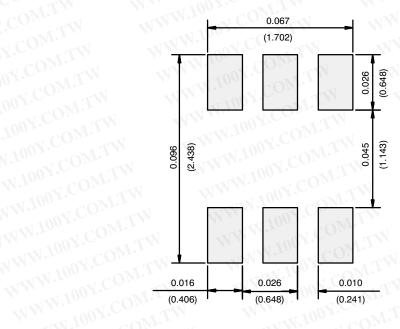
OY.COM.TW

WWW.100Y.COM.TW

#### Vishay Siliconix



## WW.100Y.COM.TW **RECOMMENDED MINIMUM PADS FOR SC-70: 6-Lead**



WW.100Y.COM.TW

WWW.100Y.COM

Recommended Minimum Pads Dimensions in Inches/(mm)

WWW.100Y.COM.TW

WWW.100Y.

Return to Index

WWW.100Y.COM.TW 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 WWW.100Y.COM.TW Http://www.100y.com.tw WWW.100Y.COM.TW

IWW.100Y.COM.TW





Vishav

#### Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and/or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk and agree to fully indemnify and hold Vishay and its distributors harmless from and against any and all claims, liabilities, expenses and damages arising or resulting in connection with such use or sale, including attorneys fees, even if such claim alleges that Vishav or its distributor was negligent regarding the design or manufacture of the part. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.

> 勝 特 力 材 料 886-3-5753170 胜特力电子(上海) 86-21-34970699 胜特力电子(深圳) 86-755-83298787 Http://www. 100y. com. tw

Revision: 11-Mar-11

Document Number: 91000